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Details

Product Status	Active
Core Processor	AVR
Core Size	8-Bit
Speed	10MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	23
Program Memory Size	4KB (2K x 16)
Program Memory Type	FLASH
EEPROM Size	256 x 8
RAM Size	512 x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 6x10b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Through Hole
Package / Case	28-DIP (0.300", 7.62mm)
Supplier Device Package	28-PDIP
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/atmega48v-10pu

Table 6-4. Start-up Times for the Low Power Crystal Oscillator Clock Selection (Continued)

Oscillator Source / Power Conditions	Start-up Time from Power-down and Power-save	Additional Delay from Reset ($V_{CC} = 5.0V$)	CKSEL0	SUT1..0
Crystal Oscillator, BOD enabled	16K CK	14CK	1	01
Crystal Oscillator, fast rising power	16K CK	14CK + 4.1 ms	1	10
Crystal Oscillator, slowly rising power	16K CK	14CK + 65 ms	1	11

- Notes:
1. These options should only be used when not operating close to the maximum frequency of the device, and only if frequency stability at start-up is not important for the application. These options are not suitable for crystals.
 2. These options are intended for use with ceramic resonators and will ensure frequency stability at start-up. They can also be used with crystals when not operating close to the maximum frequency of the device, and if frequency stability at start-up is not important for the application.

6.4 Full Swing Crystal Oscillator

Pins XTAL1 and XTAL2 are input and output, respectively, of an inverting amplifier which can be configured for use as an On-chip Oscillator, as shown in [Figure 6-2](#). Either a quartz crystal or a ceramic resonator may be used.

This Crystal Oscillator is a full swing oscillator, with rail-to-rail swing on the XTAL2 output. This is useful for driving other clock inputs and in noisy environments. The current consumption is higher than the "Low Power Crystal Oscillator" on page 27. Note that the Full Swing Crystal Oscillator will only operate for $V_{CC} = 2.7 - 5.5$ volts.

C1 and C2 should always be equal for both crystals and resonators. The optimal value of the capacitors depends on the crystal or resonator in use, the amount of stray capacitance, and the electromagnetic noise of the environment. Some initial guidelines for choosing capacitors for use with crystals are given in [Table 6-6](#). For ceramic resonators, the capacitor values given by the manufacturer should be used.

The operating mode is selected by the fuses CKSEL3..1 as shown in [Table 6-5](#).

Table 6-5. Full Swing Crystal Oscillator operating modes⁽²⁾

Frequency Range ⁽¹⁾ (MHz)	Recommended Range for Capacitors C1 and C2 (pF)	CKSEL3..1
0.4 - 20	12 - 22	011

- Notes:
1. The frequency ranges are preliminary values. Actual values are TBD.
 2. If 8 MHz frequency exceeds the specification of the device (depends on V_{CC}), the CKDIV8 Fuse can be programmed in order to divide the internal frequency by 8. It must be ensured that the resulting divided clock meets the frequency specification of the device.

8. System Control and Reset

8.0.1 Resetting the AVR

During reset, all I/O Registers are set to their initial values, and the program starts execution from the Reset Vector. For the ATmega168, the instruction placed at the Reset Vector must be a JMP – Absolute Jump – instruction to the reset handling routine. For the ATmega48 and ATmega88, the instruction placed at the Reset Vector must be an RJMP – Relative Jump – instruction to the reset handling routine. If the program never enables an interrupt source, the Interrupt Vectors are not used, and regular program code can be placed at these locations. This is also the case if the Reset Vector is in the Application section while the Interrupt Vectors are in the Boot section or vice versa (ATmega88/168 only). The circuit diagram in [Figure 8-1](#) shows the reset logic. [Table 8-1](#) defines the electrical parameters of the reset circuitry.

The I/O ports of the AVR are immediately reset to their initial state when a reset source goes active. This does not require any clock source to be running.

After all reset sources have gone inactive, a delay counter is invoked, stretching the internal reset. This allows the power to reach a stable level before normal operation starts. The time-out period of the delay counter is defined by the user through the SUT and CKSEL Fuses. The different selections for the delay period are presented in ["Clock Sources" on page 26](#).

8.0.2 Reset Sources

The ATmega48/88/168 has four sources of reset:

- Power-on Reset. The MCU is reset when the supply voltage is below the Power-on Reset threshold (V_{POT}).
- External Reset. The MCU is reset when a low level is present on the \overline{RESET} pin for longer than the minimum pulse length.
- Watchdog System Reset. The MCU is reset when the Watchdog Timer period expires and the Watchdog System Reset mode is enabled.
- Brown-out Reset. The MCU is reset when the supply voltage V_{CC} is below the Brown-out Reset threshold (V_{BOT}) and the Brown-out Detector is enabled.

Note: If the Watchdog is accidentally enabled, for example by a runaway pointer or brown-out condition, the device will be reset and the Watchdog Timer will stay enabled. If the code is not set up to handle the Watchdog, this might lead to an eternal loop of time-out resets. To avoid this situation, the application software should always clear the Watchdog System Reset Flag (WDRF) and the WDE control bit in the initialisation routine, even if the Watchdog is not in use.

The following code example shows one assembly and one C function for changing the time-out value of the Watchdog Timer.

Assembly Code Example⁽¹⁾

```
WDT_Prescaler_Change:
    ; Turn off global interrupt
    cli
    ; Reset Watchdog Timer
    wdr
    ; Start timed sequence
    lds r16, WDTCR
    ori r16, (1<<WDCE) | (1<<WDE)
    sts WDTCR, r16
    ; -- Got four cycles to set the new values from here -
    ; Set new prescaler(time-out) value = 64K cycles (~0.5 s)
    ldi r16, (1<<WDE) | (1<<WDP2) | (1<<WDP0)
    sts WDTCR, r16
    ; -- Finished setting new values, used 2 cycles -
    ; Turn on global interrupt
    sei
    ret
```

C Code Example⁽¹⁾

```
void WDT_Prescaler_Change(void)
{
    __disable_interrupt();
    __watchdog_reset();
    /* Start timed sequence */
    WDTCR |= (1<<WDCE) | (1<<WDE);
    /* Set new prescaler(time-out) value = 64K cycles (~0.5 s) */
    WDTCR = (1<<WDE) | (1<<WDP2) | (1<<WDP0);
    __enable_interrupt();
}
```

Note: 1. See "About Code Examples" on page 6.

Note: The Watchdog Timer should be reset before any change of the WDP bits, since a change in the WDP bits can result in a time-out when switching to a shorter time-out period.

- **Bit 0 – IVCE: Interrupt Vector Change Enable**

The IVCE bit must be written to logic one to enable change of the IVSEL bit. IVCE is cleared by hardware four cycles after it is written or when IVSEL is written. Setting the IVCE bit will disable interrupts, as explained in the IVSEL description above. See Code Example below.

Assembly Code Example

```
Move_interrupts:
    ; Enable change of Interrupt Vectors
    ldi r16, (1<<IVCE)
    out MCUCR, r16
    ; Move interrupts to Boot Flash section
    ldi r16, (1<<IVSEL)
    out MCUCR, r16
    ret
```

C Code Example

```
void Move_interrupts(void)
{
    /* Enable change of Interrupt Vectors */
    MCUCR = (1<<IVCE);
    /* Move interrupts to Boot Flash section */
    MCUCR = (1<<IVSEL);
}
```

This bit is not available in ATmega48.

Assembly Code Example⁽¹⁾

```
TIM16_ReadTCNT1:
    ; Save global interrupt flag
    in r18,SREG
    ; Disable interrupts
    cli
    ; Read TCNT1 into r17:r16
    in r16,TCNT1L
    in r17,TCNT1H
    ; Restore global interrupt flag
    out SREG,r18
    ret
```

C Code Example⁽¹⁾

```
unsigned int TIM16_ReadTCNT1( void )
{
    unsigned char sreg;
    unsigned int i;
    /* Save global interrupt flag */
    sreg = SREG;
    /* Disable interrupts */
    _CLI();
    /* Read TCNT1 into i */
    i = TCNT1;
    /* Restore global interrupt flag */
    SREG = sreg;
    return i;
}
```

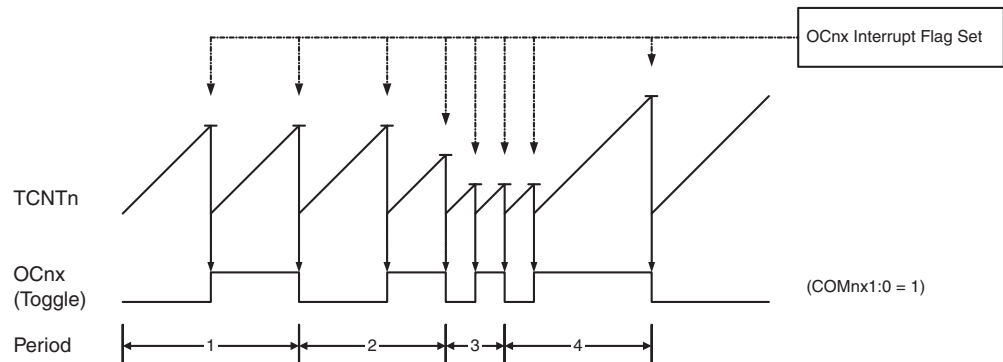
Note: 1. See ["About Code Examples" on page 6](#).

For I/O Registers located in extended I/O map, "IN", "OUT", "SBIS", "SBIC", "CBI", and "SBI" instructions must be replaced with instructions that allow access to extended I/O. Typically "LDS" and "STS" combined with "SBR", "SBRC", "SBR", and "CBR".

The assembly code example returns the TCNT1 value in the r17:r16 register pair.

The following code examples show how to do an atomic write of the TCNT1 Register contents. Writing any of the OCR1A/B or ICR1 Registers can be done by using the same principle.

Figure 15-5. CTC Mode, Timing Diagram



An interrupt can be generated each time the counter value reaches the TOP value by using the OCF2A Flag. If the interrupt is enabled, the interrupt handler routine can be used for updating the TOP value. However, changing TOP to a value close to BOTTOM when the counter is running with none or a low prescaler value must be done with care since the CTC mode does not have the double buffering feature. If the new value written to OCR2A is lower than the current value of TCNT2, the counter will miss the compare match. The counter will then have to count to its maximum value (0xFF) and wrap around starting at 0x00 before the compare match can occur.

For generating a waveform output in CTC mode, the OC2A output can be set to toggle its logical level on each compare match by setting the Compare Output mode bits to toggle mode (COM2A1:0 = 1). The OC2A value will not be visible on the port pin unless the data direction for the pin is set to output. The waveform generated will have a maximum frequency of $f_{OC2A} = f_{clk_I/O}/2$ when OCR2A is set to zero (0x00). The waveform frequency is defined by the following equation:

$$f_{OCnx} = \frac{f_{clk_I/O}}{2 \cdot N \cdot (1 + OCRnx)}$$

The N variable represents the prescale factor (1, 8, 32, 64, 128, 256, or 1024).

As for the Normal mode of operation, the TOV2 Flag is set in the same timer clock cycle that the counter counts from MAX to 0x00.

15.6.3 Fast PWM Mode

The fast Pulse Width Modulation or fast PWM mode (WGM22:0 = 3 or 7) provides a high frequency PWM waveform generation option. The fast PWM differs from the other PWM option by its single-slope operation. The counter counts from BOTTOM to TOP then restarts from BOTTOM. TOP is defined as 0xFF when WGM2:0 = 3, and OCR2A when MGM2:0 = 7. In non-inverting Compare Output mode, the Output Compare (OC2x) is cleared on the compare match between TCNT2 and OCR2x, and set at BOTTOM. In inverting Compare Output mode, the output is set on compare match and cleared at BOTTOM. Due to the single-slope operation, the operating frequency of the fast PWM mode can be twice as high as the phase correct PWM mode that uses dual-slope operation. This high frequency makes the fast PWM mode well suited for power regulation, rectification, and DAC applications. High frequency allows physically small sized external components (coils, capacitors), and therefore reduces total system cost.

nine data bits, then the ninth bit (RXB8n) is used for identifying address and data frames. When the frame type bit (the first stop or the ninth bit) is one, the frame contains an address. When the frame type bit is zero the frame is a data frame.

The Multi-processor Communication mode enables several slave MCUs to receive data from a master MCU. This is done by first decoding an address frame to find out which MCU has been addressed. If a particular slave MCU has been addressed, it will receive the following data frames as normal, while the other slave MCUs will ignore the received frames until another address frame is received.

17.8.1 Using MPCMn

For an MCU to act as a master MCU, it can use a 9-bit character frame format (UCSZn = 7). The ninth bit (TXB8n) must be set when an address frame (TXB8n = 1) or cleared when a data frame (TXB = 0) is being transmitted. The slave MCUs must in this case be set to use a 9-bit character frame format.

The following procedure should be used to exchange data in Multi-processor Communication mode:

1. All Slave MCUs are in Multi-processor Communication mode (MPCMn in UCSRnA is set).
2. The Master MCU sends an address frame, and all slaves receive and read this frame. In the Slave MCUs, the RXCn Flag in UCSRnA will be set as normal.
3. Each Slave MCU reads the UDRn Register and determines if it has been selected. If so, it clears the MPCMn bit in UCSRnA, otherwise it waits for the next address byte and keeps the MPCMn setting.
4. The addressed MCU will receive all data frames until a new address frame is received. The other Slave MCUs, which still have the MPCMn bit set, will ignore the data frames.
5. When the last data frame is received by the addressed MCU, the addressed MCU sets the MPCMn bit and waits for a new address frame from master. The process then repeats from 2.

Using any of the 5- to 8-bit character frame formats is possible, but impractical since the Receiver must change between using n and n+1 character frame formats. This makes full-duplex operation difficult since the Transmitter and Receiver uses the same character size setting. If 5- to 8-bit character frames are used, the Transmitter must be set to use two stop bit (USBSn = 1) since the first stop bit is used for indicating the frame type.

Do not use Read-Modify-Write instructions (SBI and CBI) to set or clear the MPCMn bit. The MPCMn bit shares the same I/O location as the TXCn Flag and this might accidentally be cleared when using SBI or CBI instructions.

Table 17-9. Examples of UBRRn Settings for Commonly Used Oscillator Frequencies

Baud Rate (bps)	$f_{osc} = 1.0000 \text{ MHz}$				$f_{osc} = 1.8432 \text{ MHz}$				$f_{osc} = 2.0000 \text{ MHz}$			
	U2Xn = 0		U2Xn = 1		U2Xn = 0		U2Xn = 1		U2Xn = 0		U2Xn = 1	
	UBRR n	Error	UBRR n	Error	UBRR n	Error	UBRR n	Error	UBRR n	Error	UBRR n	Error
2400	25	0.2%	51	0.2%	47	0.0%	95	0.0%	51	0.2%	103	0.2%
4800	12	0.2%	25	0.2%	23	0.0%	47	0.0%	25	0.2%	51	0.2%
9600	6	-7.0%	12	0.2%	11	0.0%	23	0.0%	12	0.2%	25	0.2%
14.4k	3	8.5%	8	-3.5%	7	0.0%	15	0.0%	8	-3.5%	16	2.1%
19.2k	2	8.5%	6	-7.0%	5	0.0%	11	0.0%	6	-7.0%	12	0.2%
28.8k	1	8.5%	3	8.5%	3	0.0%	7	0.0%	3	8.5%	8	-3.5%
38.4k	1	-18.6%	2	8.5%	2	0.0%	5	0.0%	2	8.5%	6	-7.0%
57.6k	0	8.5%	1	8.5%	1	0.0%	3	0.0%	1	8.5%	3	8.5%
76.8k	—	—	1	-18.6%	1	-25.0%	2	0.0%	1	-18.6%	2	8.5%
115.2k	—	—	0	8.5%	0	0.0%	1	0.0%	0	8.5%	1	8.5%
230.4k	—	—	—	—	—	—	0	0.0%	—	—	—	—
250k	—	—	—	—	—	—	—	—	—	—	0	0.0%
Max. ⁽¹⁾	62.5 kbps		125 kbps		115.2 kbps		230.4 kbps		125 kbps		250 kbps	

Note: 1. UBRRn = 0, Error = 0.0%

The PRTWI bit in ["Power Reduction Register - PRR" on page 40](#) must be written to zero to enable the 2-wire Serial Interface.

19.2.2 Electrical Interconnection

As depicted in [Figure 19-1](#), both bus lines are connected to the positive supply voltage through pull-up resistors. The bus drivers of all TWI-compliant devices are open-drain or open-collector. This implements a wired-AND function which is essential to the operation of the interface. A low level on a TWI bus line is generated when one or more TWI devices output a zero. A high level is output when all TWI devices tri-state their outputs, allowing the pull-up resistors to pull the line high. Note that all AVR devices connected to the TWI bus must be powered in order to allow any bus operation.

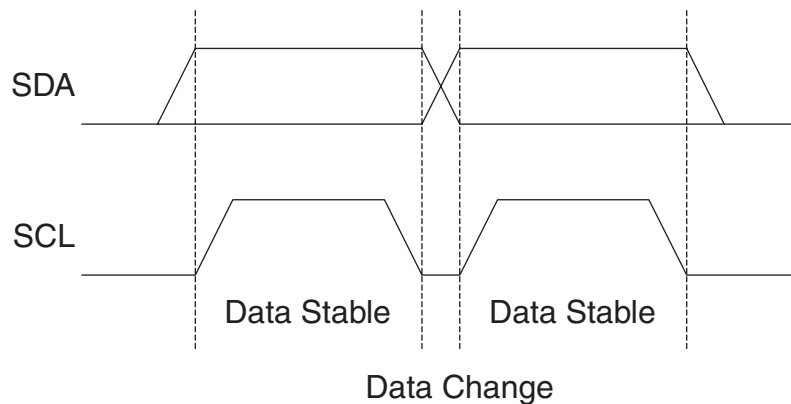
The number of devices that can be connected to the bus is only limited by the bus capacitance limit of 400 pF and the 7-bit slave address space. A detailed specification of the electrical characteristics of the TWI is given in ["2-wire Serial Interface Characteristics" on page 302](#). Two different sets of specifications are presented there, one relevant for bus speeds below 100 kHz, and one valid for bus speeds up to 400 kHz.

19.3 Data Transfer and Frame Format

19.3.1 Transferring Bits

Each data bit transferred on the TWI bus is accompanied by a pulse on the clock line. The level of the data line must be stable when the clock line is high. The only exception to this rule is for generating start and stop conditions.

Figure 19-2. Data Validity



19.3.2 START and STOP Conditions

The Master initiates and terminates a data transmission. The transmission is initiated when the Master issues a START condition on the bus, and it is terminated when the Master issues a STOP condition. Between a START and a STOP condition, the bus is considered busy, and no other master should try to seize control of the bus. A special case occurs when a new START condition is issued between a START and STOP condition. This is referred to as a REPEATED START condition, and is used when the Master wishes to initiate a new transfer without relinquishing control of the bus. After a REPEATED START, the bus is considered busy until the next STOP. This is identical to the START behavior, and therefore START is used to describe both START and REPEATED START for the remainder of this datasheet, unless otherwise noted. As

- **Bit 6 – TWEA: TWI Enable Acknowledge Bit**

The TWEA bit controls the generation of the acknowledge pulse. If the TWEA bit is written to one, the ACK pulse is generated on the TWI bus if the following conditions are met:

1. The device's own slave address has been received.
2. A general call has been received, while the TWGCE bit in the TWAR is set.
3. A data byte has been received in Master Receiver or Slave Receiver mode.

By writing the TWEA bit to zero, the device can be virtually disconnected from the 2-wire Serial Bus temporarily. Address recognition can then be resumed by writing the TWEA bit to one again.

- **Bit 5 – TWSTA: TWI START Condition Bit**

The application writes the TWSTA bit to one when it desires to become a Master on the 2-wire Serial Bus. The TWI hardware checks if the bus is available, and generates a START condition on the bus if it is free. However, if the bus is not free, the TWI waits until a STOP condition is detected, and then generates a new START condition to claim the bus Master status. TWSTA must be cleared by software when the START condition has been transmitted.

- **Bit 4 – TWSTO: TWI STOP Condition Bit**

Writing the TWSTO bit to one in Master mode will generate a STOP condition on the 2-wire Serial Bus. When the STOP condition is executed on the bus, the TWSTO bit is cleared automatically. In Slave mode, setting the TWSTO bit can be used to recover from an error condition. This will not generate a STOP condition, but the TWI returns to a well-defined unaddressed Slave mode and releases the SCL and SDA lines to a high impedance state.

- **Bit 3 – TWWC: TWI Write Collision Flag**

The TWWC bit is set when attempting to write to the TWI Data Register – TWDR when TWINT is low. This flag is cleared by writing the TWDR Register when TWINT is high.

- **Bit 2 – TWEN: TWI Enable Bit**

The TWEN bit enables TWI operation and activates the TWI interface. When TWEN is written to one, the TWI takes control over the I/O pins connected to the SCL and SDA pins, enabling the slew-rate limiters and spike filters. If this bit is written to zero, the TWI is switched off and all TWI transmissions are terminated, regardless of any ongoing operation.

- **Bit 1 – Res: Reserved Bit**

This bit is a reserved bit and will always read as zero.

- **Bit 0 – TWIE: TWI Interrupt Enable**

When this bit is written to one, and the I-bit in SREG is set, the TWI interrupt request will be activated for as long as the TWINT Flag is high.

19.6.3 TWI Status Register – TWSR

Bit	7	6	5	4	3	2	1	0	
	TWS7	TWS6	TWS5	TWS4	TWS3	–	TWPS1	TWPS0	TWSR
Read/Write	R	R	R	R	R	R	R/W	R/W	
Initial Value	1	1	1	1	1	0	0	0	

- **Bits 7..3 – TWS: TWI Status**

These 5 bits reflect the status of the TWI logic and the 2-wire Serial Bus. The different status codes are described later in this section. Note that the value read from TWSR contains both the 5-bit status value and the 2-bit prescaler value. The application designer should mask the prescaler bits to zero when checking the Status bits. This makes status checking independent of prescaler setting. This approach is used in this datasheet, unless otherwise noted.

- **Bit 2 – Res: Reserved Bit**

This bit is reserved and will always read as zero.

- **Bits 1..0 – TWPS: TWI Prescaler Bits**

These bits can be read and written, and control the bit rate prescaler.

Table 19-2. TWI Bit Rate Prescaler

TWPS1	TWPS0	Prescaler Value
0	0	1
0	1	4
1	0	16
1	1	64

To calculate bit rates, see ["Bit Rate Generator Unit" on page 211](#). The value of TWPS1..0 is used in the equation.

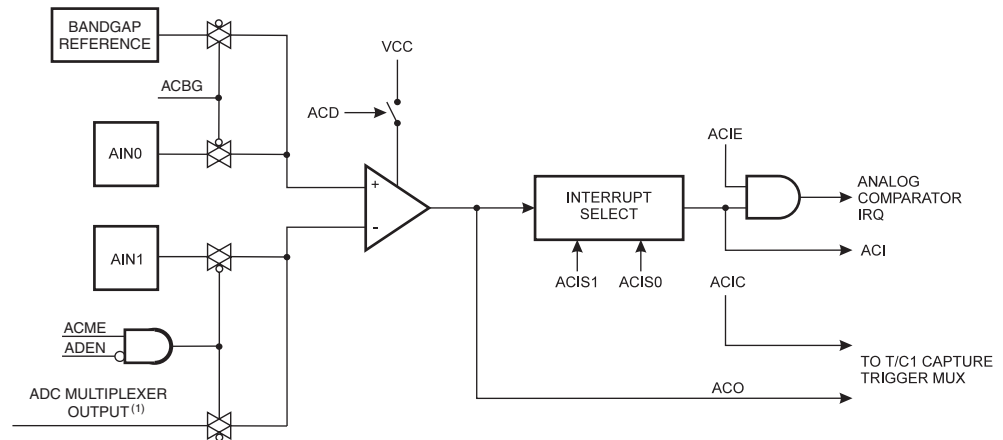
19.6.4 TWI Data Register – TWDR

Bit	7	6	5	4	3	2	1	0	
	TWD7	TWD6	TWD5	TWD4	TWD3	TWD2	TWD1	TWD0	TWDR
Read/Write	R/W	R/W	R/W	R/W	R/W	R/W	R/W	R/W	
Initial Value	1	1	1	1	1	1	1	1	

In Transmit mode, TWDR contains the next byte to be transmitted. In Receive mode, the TWDR contains the last byte received. It is writable while the TWI is not in the process of shifting a byte. This occurs when the TWI Interrupt Flag (TWINT) is set by hardware. Note that the Data Register cannot be initialized by the user before the first interrupt occurs. The data in TWDR remains stable as long as TWINT is set. While data is shifted out, data on the bus is simultaneously shifted in. TWDR always contains the last byte present on the bus, except after a wake up from a sleep mode by the TWI interrupt. In this case, the contents of TWDR is undefined. In the case of a lost bus arbitration, no data is lost in the transition from Master to Slave. Handling of the ACK bit is controlled automatically by the TWI logic, the CPU cannot access the ACK bit directly.

	Assembly Code Example	C Example	Comments
1	<pre>ldi r16, (1<<TWINT) (1<<TWSTA) (1<<TWEN) out TWCR, r16</pre>	<pre>TWCR = (1<<TWINT) (1<<TWSTA) (1<<TWEN)</pre>	Send START condition
2	<pre>wait1: in r16,TWCR sbrs r16,TWINT rjmp wait1</pre>	<pre>while (!(TWCR & (1<<TWINT))) ;</pre>	Wait for TWINT Flag set. This indicates that the START condition has been transmitted
3	<pre>in r16,TWSR andi r16, 0xF8 cpi r16, START brne ERROR</pre>	<pre>if ((TWSR & 0xF8) != START) ERROR();</pre>	Check value of TWI Status Register. Mask prescaler bits. If status different from START go to ERROR
	<pre>ldi r16, SLA_W out TWDR, r16 ldi r16, (1<<TWINT) (1<<TWEN) out TWCR, r16</pre>	<pre>TWDR = SLA_W; TWCR = (1<<TWINT) (1<<TWEN);</pre>	Load SLA_W into TWDR Register. Clear TWINT bit in TWCR to start transmission of address
4	<pre>wait2: in r16,TWCR sbrs r16,TWINT rjmp wait2</pre>	<pre>while (!(TWCR & (1<<TWINT))) ;</pre>	Wait for TWINT Flag set. This indicates that the SLA+W has been transmitted, and ACK/NACK has been received.
5	<pre>in r16,TWSR andi r16, 0xF8 cpi r16, MT_SLA_ACK brne ERROR</pre>	<pre>if ((TWSR & 0xF8) != MT_SLA_ACK) ERROR();</pre>	Check value of TWI Status Register. Mask prescaler bits. If status different from MT_SLA_ACK go to ERROR
	<pre>ldi r16, DATA out TWDR, r16 ldi r16, (1<<TWINT) (1<<TWEN) out TWCR, r16</pre>	<pre>TWDR = DATA; TWCR = (1<<TWINT) (1<<TWEN);</pre>	Load DATA into TWDR Register. Clear TWINT bit in TWCR to start transmission of data
6	<pre>wait3: in r16,TWCR sbrs r16,TWINT rjmp wait3</pre>	<pre>while (!(TWCR & (1<<TWINT))) ;</pre>	Wait for TWINT Flag set. This indicates that the DATA has been transmitted, and ACK/NACK has been received.
7	<pre>in r16,TWSR andi r16, 0xF8 cpi r16, MT_DATA_ACK brne ERROR</pre>	<pre>if ((TWSR & 0xF8) != MT_DATA_ACK) ERROR();</pre>	Check value of TWI Status Register. Mask prescaler bits. If status different from MT_DATA_ACK go to ERROR
	<pre>ldi r16, (1<<TWINT) (1<<TWEN) (1<<TWSTO) out TWCR, r16</pre>	<pre>TWCR = (1<<TWINT) (1<<TWEN) (1<<TWSTO);</pre>	Transmit STOP condition

Figure 20-1. Analog Comparator Block Diagram⁽²⁾



- Notes: 1. See [Table 20-2 on page 238](#).
2. Refer to [Figure 1-1 on page 2](#) and [Table 10-9 on page 78](#) for Analog Comparator pin placement.

20.0.1 ADC Control and Status Register B – ADCSRB

Bit	7	6	5	4	3	2	1	0	
	–	ACME	–	–	–	ADTS2	ADTS1	ADTS0	ADCSRB
Read/Write	R	R/W	R	R	R	R/W	R/W	R/W	
Initial Value	0	0	0	0	0	0	0	0	

• Bit 6 – ACME: Analog Comparator Multiplexer Enable

When this bit is written logic one and the ADC is switched off (ADEN in ADCSRA is zero), the ADC multiplexer selects the negative input to the Analog Comparator. When this bit is written logic zero, AIN1 is applied to the negative input of the Analog Comparator. For a detailed description of this bit, see ["Analog Comparator Multiplexed Input" on page 237](#).

20.0.2 Analog Comparator Control and Status Register – ACSR

Bit	7	6	5	4	3	2	1	0	
	ACD	ACBG	ACO	ACI	ACIE	ACIC	ACIS1	ACIS0	ACSR
Read/Write	R/W	R/W	R	R/W	R/W	R/W	R/W	R/W	
Initial Value	0	0	N/A	0	0	0	0	0	

• Bit 7 – ACD: Analog Comparator Disable

When this bit is written logic one, the power to the Analog Comparator is switched off. This bit can be set at any time to turn off the Analog Comparator. This will reduce power consumption in Active and Idle mode. When changing the ACD bit, the Analog Comparator Interrupt must be disabled by clearing the ACIE bit in ACSR. Otherwise an interrupt can occur when the bit is changed.

• Bit 6 – ACBG: Analog Comparator Bandgap Select

When this bit is set, a fixed bandgap reference voltage replaces the positive input to the Analog Comparator. When this bit is cleared, AIN0 is applied to the positive input of the Analog Comparator. See [Section "8.1" on page 48](#).

22. debugWIRE On-chip Debug System

22.1 Features

- Complete Program Flow Control
- Emulates All On-chip Functions, Both Digital and Analog, except RESET Pin
- Real-time Operation
- Symbolic Debugging Support (Both at C and Assembler Source Level, or for Other HLLs)
- Unlimited Number of Program Break Points (Using Software Break Points)
- Non-intrusive Operation
- Electrical Characteristics Identical to Real Device
- Automatic Configuration System
- High-Speed Operation
- Programming of Non-volatile Memories

22.2 Overview

The debugWIRE On-chip debug system uses a One-wire, bi-directional interface to control the program flow, execute AVR instructions in the CPU and to program the different non-volatile memories.

22.3 Physical Interface

When the debugWIRE Enable (DWEN) Fuse is programmed and Lock bits are unprogrammed, the debugWIRE system within the target device is activated. The RESET port pin is configured as a wire-AND (open-drain) bi-directional I/O pin with pull-up enabled and becomes the communication gateway between target and emulator.

Figure 22-1. The debugWIRE Setup

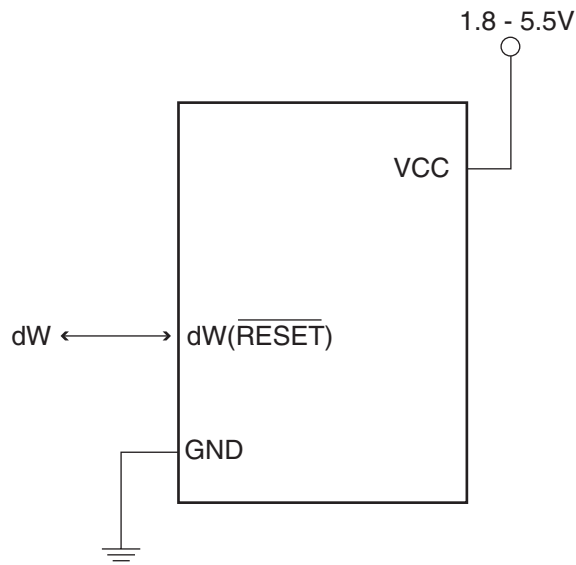


Figure 22-1 shows the schematic of a target MCU, with debugWIRE enabled, and the emulator connector. The system clock is not affected by debugWIRE and will always be the clock source selected by the CKSEL Fuses.

Table 25-17. Serial Programming Instruction Set (Continued)

Instruction	Instruction Format				Operation
	Byte 1	Byte 2	Byte 3	Byte4	
Load EEPROM Memory Page (page access)	1100 0001	0000 0000	0000 00 bb	iiii iiii	Load data i to EEPROM memory page buffer. After data is loaded, program EEPROM page.
Write EEPROM Memory Page (page access)	1100 0010	00 xx xxaa	bbbb bb00	xxxx xxxx	Write EEPROM page at address a:b .
Read Lock bits	0101 1000	0000 0000	xxxx xxxx	xx00 0000	Read Lock bits. “0” = programmed, “1” = unprogrammed. See Table 25-1 on page 280 for details.
Write Lock bits	1010 1100	111 x xxxx	xxxx xxxx	11 ii iiii	Write Lock bits. Set bits = “0” to program Lock bits. See Table 25-1 on page 280 for details.
Read Signature Byte	0011 0000	000 x xxxx	xxxx xxbb	0000 0000	Read Signature Byte o at address b .
Write Fuse bits	1010 1100	1010 0000	xxxx xxxx	iiii iiii	Set bits = “0” to program, “1” to unprogram. See Table XXX on page XXX for details.
Write Fuse High bits	1010 1100	1010 1000	xxxx xxxx	iiii iiii	Set bits = “0” to program, “1” to unprogram. See Table 21-1 on page 244 for details.
Write Extended Fuse Bits	1010 1100	1010 0100	xxxx xxxx	xxxx xxii	Set bits = “0” to program, “1” to unprogram. See Table 25-4 on page 281 for details.
Read Fuse bits	0101 0000	0000 0000	xxxx xxxx	0000 0000	Read Fuse bits. “0” = programmed, “1” = unprogrammed. See Table XXX on page XXX for details.
Read Fuse High bits	0101 1000	0000 1000	xxxx xxxx	0000 0000	Read Fuse High bits. “0” = programmed, “1” = unprogrammed. See Table 21-1 on page 244 for details.
Read Extended Fuse Bits	0101 0000	0000 1000	xxxx xxxx	0000 0000	Read Extended Fuse bits. “0” = programmed, “1” = unprogrammed. See Table 25-4 on page 281 for details.
Read Calibration Byte	0011 1000	000 x xxxx	0000 0000	0000 0000	Read Calibration Byte
Poll RDY/ $\overline{\text{BSY}}$	1111 0000	0000 0000	xxxx xxxx	xxxx xxxo	If o = “1”, a programming operation is still busy. Wait until this bit returns to “0” before applying another command.

Note: **a** = address high bits, **b** = address low bits, **H** = 0 - Low byte, 1 - High Byte, **o** = data out, **i** = data in, **x** = don't care

25.9.2 SPI Serial Programming Characteristics

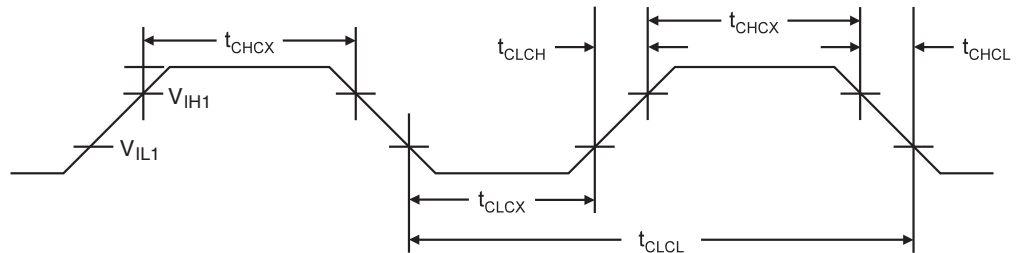
For characteristics of the SPI module see “SPI Timing Characteristics” on page 304.

If IOH exceeds the test condition, VOH may exceed the related specification. Pins are not guaranteed to source current greater than the listed test condition.

5. All DC Characteristics contained in this datasheet are based on simulation and characterization of other AVR microcontrollers manufactured in the same process technology. These values are preliminary values representing design targets, and will be updated after characterization of actual silicon
6. Values with "Power Reduction Register - PRR" disabled (0x00).

26.3 External Clock Drive Waveforms

Figure 26-1. External Clock Drive Waveforms



26.4 External Clock Drive

Table 26-1. External Clock Drive

Symbol	Parameter	V _{CC} =1.8-5.5V		V _{CC} =2.7-5.5V		V _{CC} =4.5-5.5V		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
1/t _{CLCL}	Oscillator Frequency	0	4	0	10	0	20	MHz
t _{CLCL}	Clock Period	250		100		50		ns
t _{CHCX}	High Time	100		40		20		ns
t _{CLCX}	Low Time	100		40		20		ns
t _{CLCH}	Rise Time		2.0		1.6		0.5	μs
t _{CHCL}	Fall Time		2.0		1.6		0.5	μs
Δt _{CLCL}	Change in period from one clock cycle to the next		2		2		2	%

Note: All DC Characteristics contained in this datasheet are based on simulation and characterization of other AVR microcontrollers manufactured in the same process technology. These values are preliminary values representing design targets, and will be updated after characterization of actual silicon.

26.5 Maximum Speed vs. V_{CC}

Maximum frequency is dependent on V_{CC}. As shown in [Figure 26-2](#) and [Figure 26-3](#), the Maximum Frequency vs. V_{CC} curve is linear between 1.8V < V_{CC} < 2.7V and between 2.7V < V_{CC} < 4.5V.

Figure 27-4. Active Supply Current vs. V_{CC} (Internal RC Oscillator, 1 MHz)

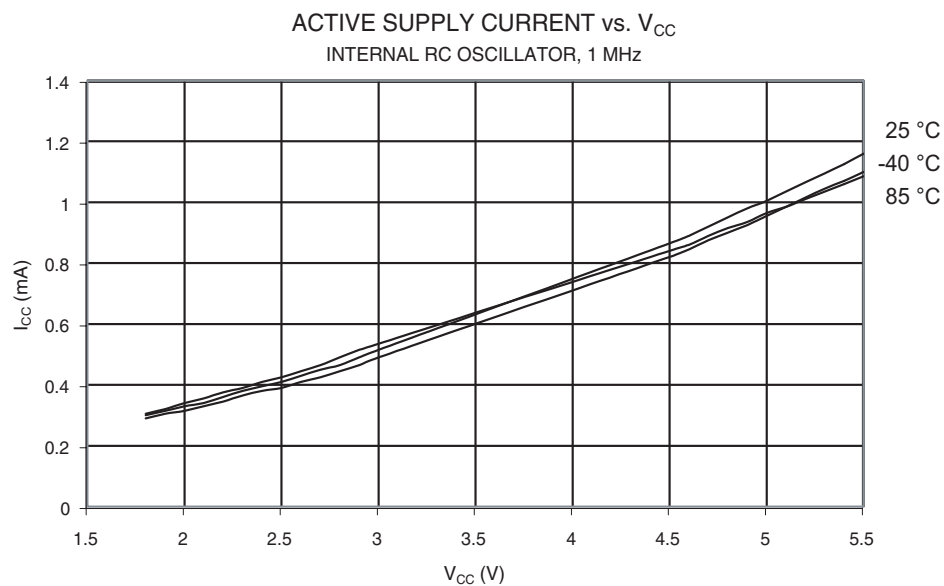
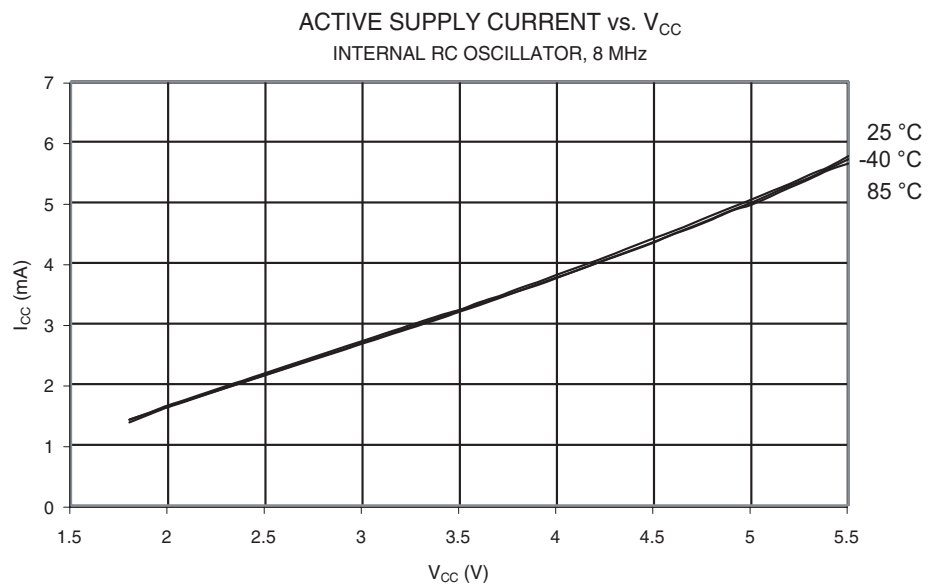
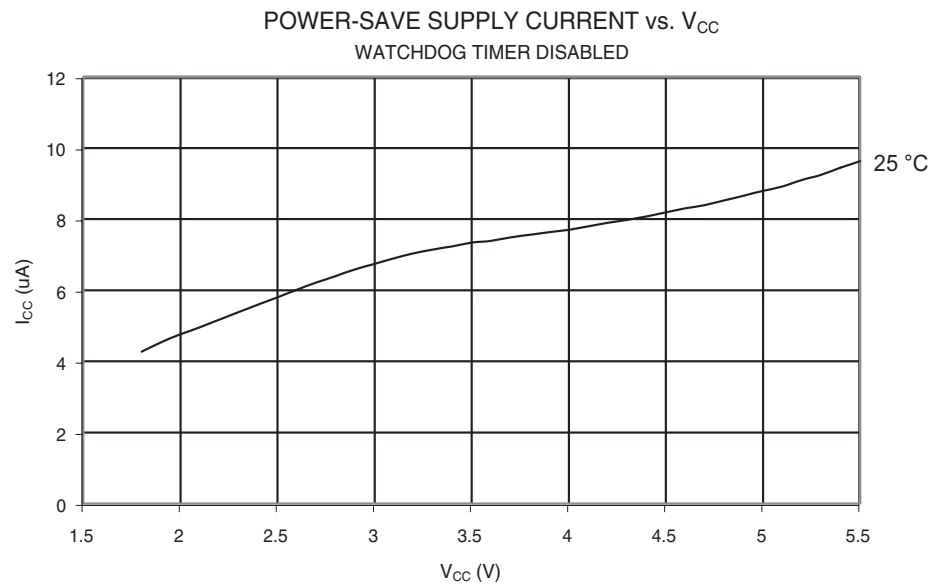


Figure 27-5. Active Supply Current vs. V_{CC} (Internal RC Oscillator, 8 MHz)



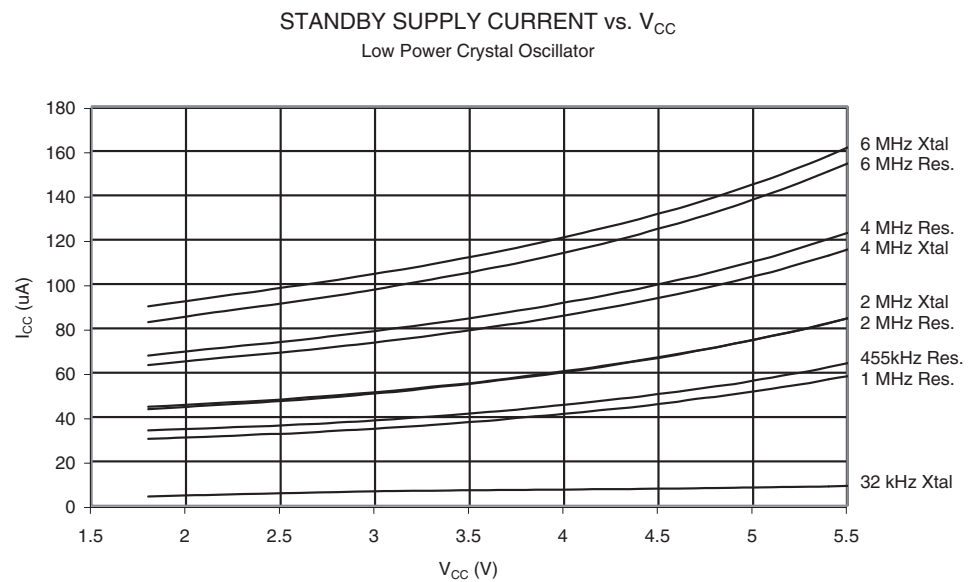
27.5 Power-Save Supply Current

Figure 27-15. Power-Save Supply Current vs. V_{CC} (Watchdog Timer Disabled)



27.6 Standby Supply Current

Figure 27-16. Standby Supply Current vs. V_{CC} (Low Power Crystal Oscillator)



27.10 BOD Thresholds and Analog Comparator Offset

Figure 27-33. BOD Thresholds vs. Temperature (BODLEVEL Is 4.0V)

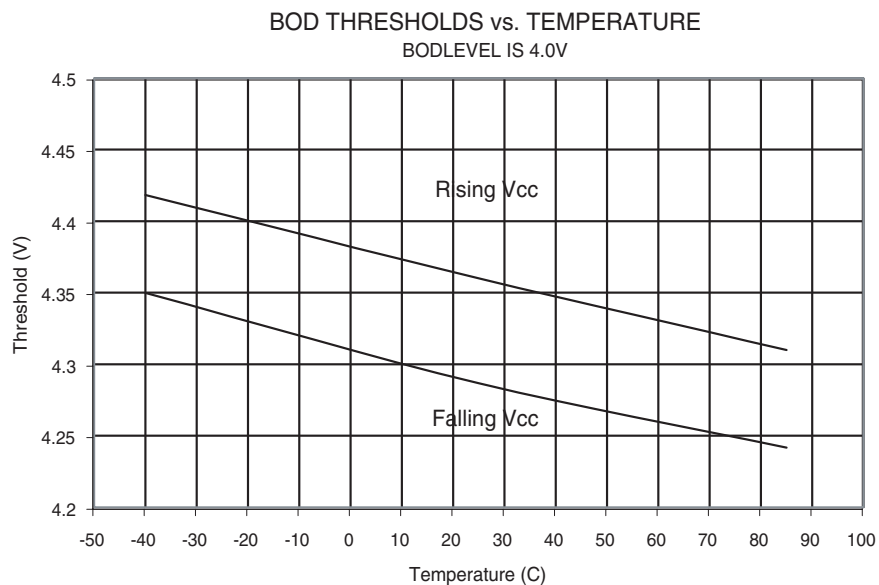
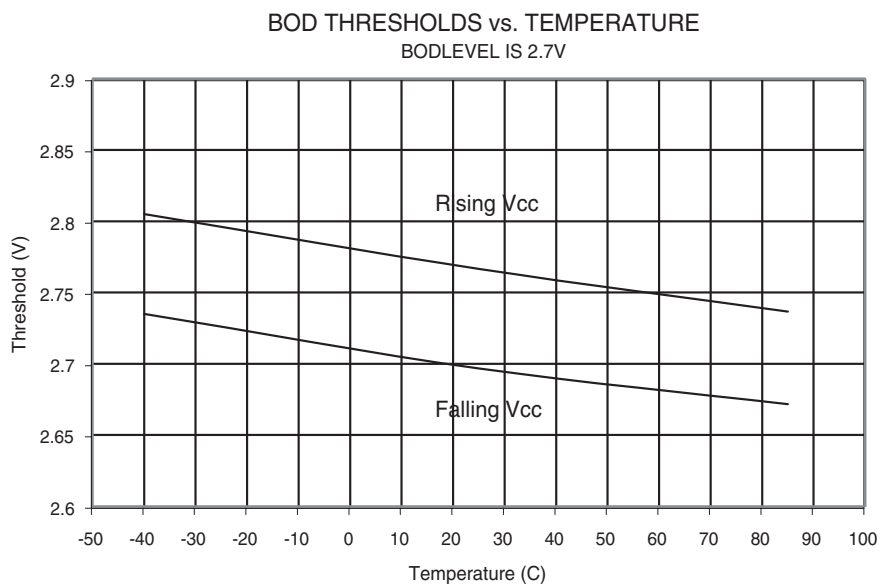


Figure 27-34. BOD Thresholds vs. Temperature (BODLEVEL Is 2.7V)



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